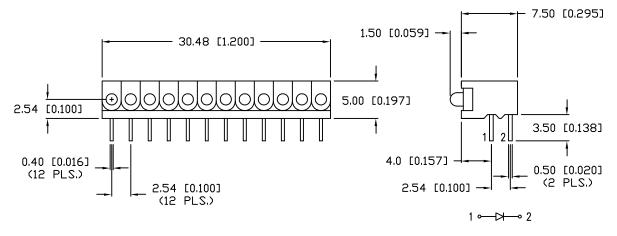
## SSF-H1230USBD-12



ELECTRO-OPTICAL CH	ARACTERIS	STICS TA=25°	С	$I_f = 20 \text{mA}$	
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		470		nm	
FORWARD VOLTAGE		3.5	4.0	٧ <sub>f</sub>	
REVERSE VOLTAGE	5.0			$v_r$	Ir=100µA
AXIAL INTENSITY		100		mcd	$I_f = 20 \text{mA}$
VIEWING ANGLE		70		2x theta	
EMITTED COLOR:	BLUE				
EPOXY LENS FINISH:	BLUE D	IFFUSED			

## LIMITS OF SAFE OPERATION AT 25°C PER LED

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	100	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	- 1.2	mW/°C
OPERATING, STORAGE TEMP.	-40  TO  +85	•C
SOLDERING TEMP.	+ 260	<b>.</b> C
2.0mm FROM BODY		3 SEC. MAX

<sup>\*</sup> t<10µS

CAUTION: STATIC SENSITIVE DEVICE
FOLLOW PROPER E.S.D. HANDLING PROCEDURES WHEN WORKING WITH THIS PART.

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION MAX.= +0.00 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN=+DECIMAL PRECISION MAX.= +0.00 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN=+DECIMAL PRECISION MAX.= +0.00 (±0.005). LEAD SIZE=±0.05 (±0.005). LEAD SIZE=±0.05 (±0.005). LEAD SIZE=±0.05 (±0.005). MIN=+DECIMAL PRECISION MAX.= +0.00 (±0.005). LEAD SIZE=±0.05 (±0.005). LEAD SIZE=±0.05 (±0.005). LEAD SIZE=±0.05 (±0.005). MIN=+DECIMAL PRECISION MAX.= +0.00 (±0.005). LEAD SIZE=±0.05 (±0.005). LEAD SIZE=±0.05 (±0.005). MIN=+DECIMAL PRECISION MAX.= +0.00 (±0.005). LEAD SIZE=±0.05 (±0.005). MIN=+DECIMAL PRECISION MAX.= +0.00 (±0.005). MIN=+DECIMAL PRECISI

REV.

PART NUMBER SSF-H1230USBD-12

T-2mm SINGLE TOWER, 12 UNIT, FRONT-BACK LEADS, 470nm ULTRA SUPER BLUE, BLUE DIFFUSED.

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OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



CT

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CHECKED BY: APPROVED BY: DATE: DRAWN BY:

1.28.01 PAGE: 1 OF 1 SCALE: N/A